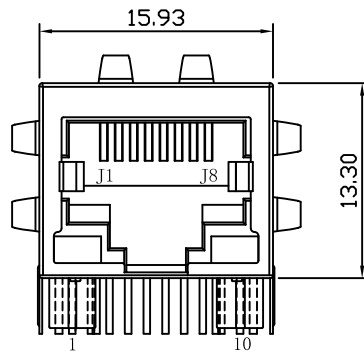
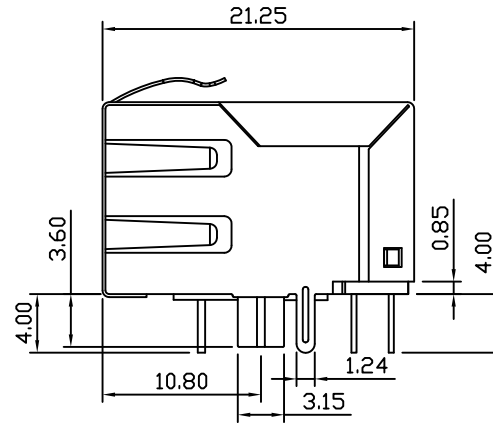


Mechanical:

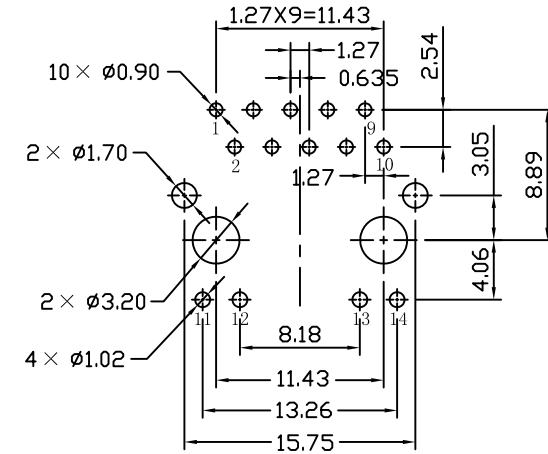
REV.	ECN NO.	DESCRIPTION	DATE	APPD
A	REL		2009-12-15	



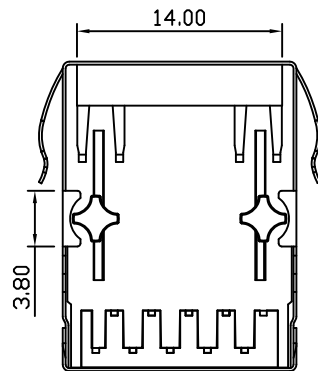
Front Side View



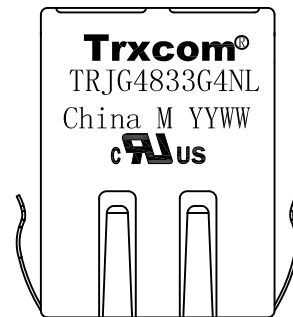
Left Side View



Suggested PCB Layout (Top View)



Bottom Side View



Top Side View

NOTES:

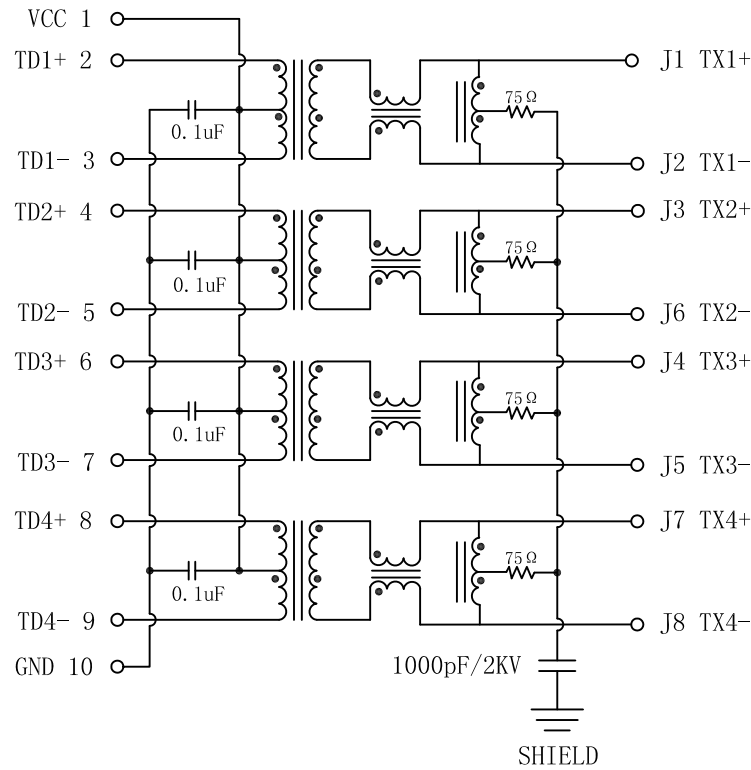
1. Designed to support application, such as SOHO (ADSL modems), LAN-on-Motherboard (LOM), hub and Switches.
2. Meets IEEE802.3 specification.
3. Connector Materials:
 Housing: Thermoplastic PBT+30%G.F UL94V-0
 Contact: Phosphor Bronze C5210R-EH Thickness=0.35mm
 Pins: Brass C2680R-H Thickness=0.35mm
 Shield: SUS 201-1/2H Thickness=0.2mm
 Contact plating: Gold 6 micro-inches min. In contact area.
4. Wave solder tip temperature: 265°C Max, 5 Sec.
5. UL Certification: File Number E321120.

X:X ±0.25	APPD:	Trxcom Huizhou Trxcom Electronics Co., Ltd.
X:XX ±0.20	CHKD:	
X:XXX ±0.05	DR: SEA	TITLE: RJ45 Connector with 1000 Base-T Integrated Magnetics
ANGLES ±1°	UNIT: mm	PART NO.: TRJG4833G4NL
	SCALE: 2/1	SHEET: 1/4
	REV: A	DWG NO.: TRC09121502

Schematic:

REV.	ECN NO.	DESCRIPTION	DATE	APPD
A	REL		2009-12-15	

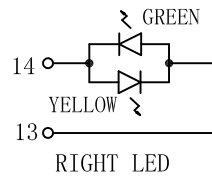
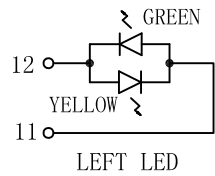
PCB CONNECTIONS



RJ45 CONNECTOR

ELECTRICAL SPECIFICATIONS @25°C

- Turn Ratio ($\pm 2\%$):
Pri:Sec = 1CT:1
- Inductance OCL:
350uH MIN @ 100KHz, 0.1V, 8mA DC Bias
- Insertion Loss:
-1.0dB MAX @ 1.0-100MHz
- Return Loss:
-18dB MIN @ 1-10MHz
-16dB MIN @ 10-30MHz
-12dB MIN @ 30-60MHz
-10dB MIN @ 60-100MHz
- Cross talk:
-35dB MIN @ 1-30MHz
-32dB MIN @ 30-60MHz
-30dB MIN @ 60-100MHz
- Common Mode Rejection:
-30dB MIN @ 1-100MHz
- Hipot Test: 1500Vrms MIN
- Operating Temperature Range: $-40^{\circ}\text{C} \sim +85^{\circ}\text{C}$.



Emitting Color	$\lambda_p(\text{nm})$	VF@IF=20mA	IR @VR=5V
GREEN	565	1.8~2.6V	10 μA max
YELLOW	585	1.8~2.6V	10 μA max

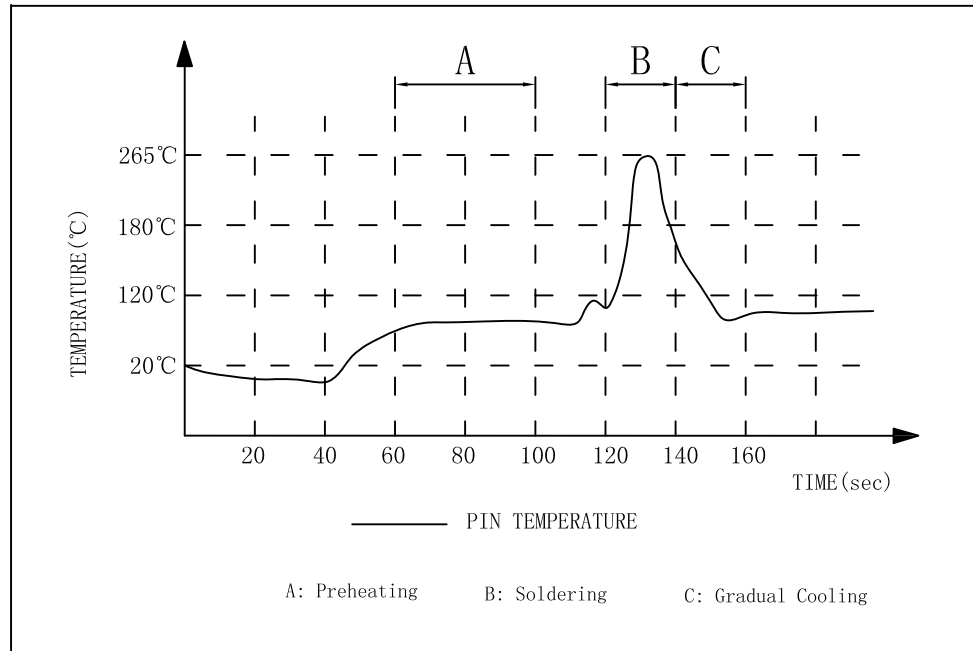
X:X	± 0.25	APPD:	Trxcom
X:XX	± 0.20	CHKD:	
X:XXX	± 0.05	DR: SEA	TITLE: RJ45 Connector with 1000 Base-T Integrated Magnetics
ANGLES	$\pm 1^{\circ}$	UNIT: mm	PART NO.: TRJG4833G4NL
	SCALE: 2/1	SHEET: 2/4	REV: A
			DWG NO.: TRC09121502

Profile of wave solder:

REV.	ECN NO.	DESCRIPTION	DATE	APPD
A	REL		2009-12-15	

SUGGESTED PROFILE OF WAVE SOLDER FOR ROHS PRODUCT

REV: A
 TEMP (°C): 25
 HUM (%): 65 RH

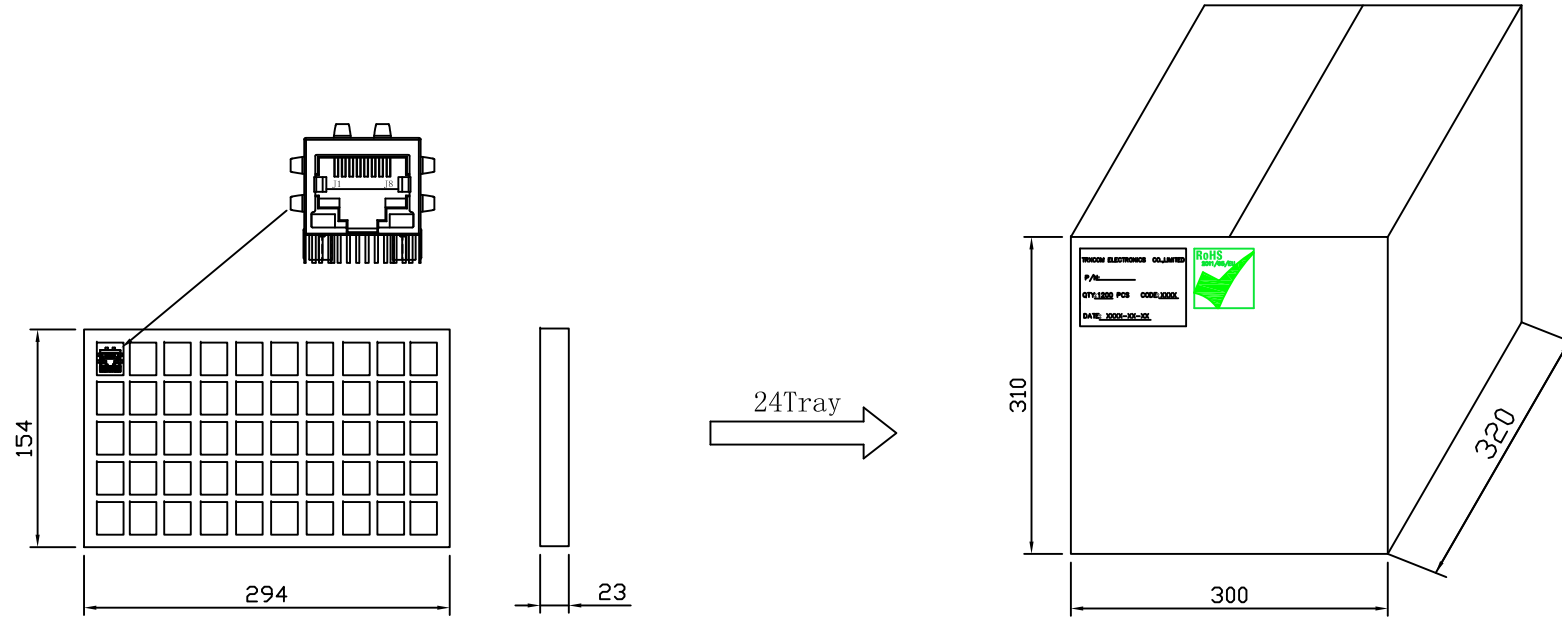


- (1) Tip Temperature: 265°C max
 - (2) Tip Temperature time: 5sec max
- Note: The melting point of Tin: 219°C

X:X ±0.25	APPD:	Trxcom
X:XX ±0.20	CHKD:	
X:XXX ±0.05	DR: SEA	TITLE: RJ45 Connector with 1000 Base-T Integrated Magnetics
ANGLES ±1°	UNIT: mm	PART NO.: TRJG4833G4NL
	SCALE: 2/1	SHEET: 3/4
	REV: A	DWG NO.: TRC09121502

Packaging:

REV.	ECN NO.	DESCRIPTION	DATE	APPD
A	REL		2009-12-15	



- ◆ Packaging unit :50pcs/tray
- ◆ Packaging material:PVC
- ◆ Outer carton unit:1200pcs/24tray/box
- ◆ Net Weight:8kg
- ◆ Gross Weight:10kg

X:X	±0.25	APPD:	Trxcom
X:XX	±0.20	CHKD:	
X:XXX	±0.05	DR: SEA	TITLE: 1*1 Port 21.25mm RJ45 Packing
ANGLES	±1°	UNIT: mm	PART NO.: TRJG4833G4NL
	SCALE: 2/1	SHEET: 4/4	REV: A
			DWG NO.: TRC09121502